

NextPower 100V, 10.9 mΩ N-channel MOSFET in LFPAK56 package

18 March 2019

Product data sheet

## 1. General description

NextPower 100V standard level gate drive MOSFET. Qualified to 175 °C and recommended for industrial & consumer applications.

## 2. Features and benefits

- Low Q<sub>rr</sub> for higher efficiency and lower spiking
- Qualified to 175 °C
- Low Q<sub>G</sub> x R<sub>DSon</sub> FOM for high efficiency switching applications
- Strong avalanche energy rating (Eas)
- Avalanche rated and 100% tested
- Ha-free and RoHS compliant LFPAK56 package
- Wave-solderable LFPAK56 package
- · Low-stress LFPAK leadframe for high-reliability applications

## 3. Applications

- Synchronous rectifier in AC-DC and DC-DC
- BLDC motor control
- USB-PD and mobile fast-charge adapters
- LED lighting
- Full-bridge and half-bridge applications
- Flyback and resonant topologies

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 175 °C	-	-	100	V
ID	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	-	-	79.5	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>	-	-	152	W
Tj	junction temperature		-55	-	175	°C
Static chara	acteristics	,				
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 25 °C; Fig. 12	-	8.8	10.9	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 100 °C; Fig. 13	-	13.9	17.7	mΩ
Dynamic ch	naracteristics			I		
Q <sub>GD</sub>	gate-drain charge	$I_D$ = 20 A; $V_{DS}$ = 50 V; $V_{GS}$ = 10 V;	-	8.1	-	nC
Q <sub>G(tot)</sub>	total gate charge	<u>Fig. 14; Fig. 15</u>	-	34.3	-	nC
Avalanche	ruggedness					

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$\label{eq:ld} \begin{array}{l} I_{D} = 27 \; A; \; V_{sup} \leq \; 100 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = \; 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ \hline Fig. 4 \end{array}$	[1]	-	-	173	mJ
Source-drain d	Source-drain diode						
Q <sub>r</sub>	recovered charge	$I_{S} = 20 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 50 \text{ V}; \text{ Fig. 18}$		-	36.5	-	nC

[1] Protected by 100% test

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	mb	D
2	S	source		
3	S	source	a	G_(I=A)
4	G	gate		mbb076 S
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT669)	

## 6. Ordering information

#### Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PSMN011-100YSF	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package; 4 terminals	SOT669		

## 7. Marking

Table 4. Marking codes	
Type number	Marking code
PSMN011-100YSF	11FS10Y

## 8. Limiting values

#### Table 5. Limiting values

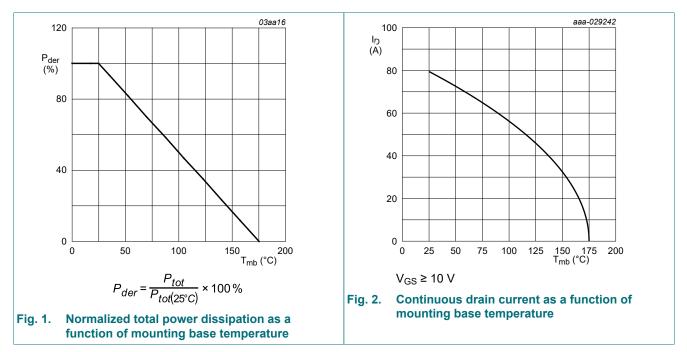
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	$25 \text{ °C} \leq T_j \leq 175 \text{ °C}$	-	100	V
V <sub>DGR</sub>	drain-gate voltage	25 °C ≤ $T_j$ ≤ 175 °C; $R_{GS}$ = 20 kΩ	-	100	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>	-	152	W
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	-	79.5	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>	-	56.2	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^\circ C$ ; Fig. 3	-	318	А

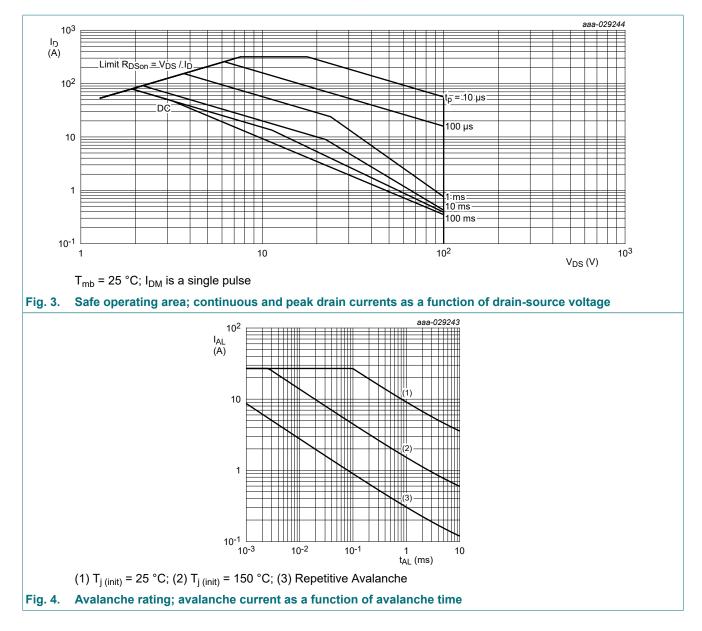
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Symbol	Parameter	Conditions		Min	Max	Unit
T <sub>stg</sub>	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
Source-drain c	liode					_
ls	source current	T <sub>mb</sub> = 25 °C		-	79.5	А
I <sub>SM</sub>	peak source current	pulsed; t <sub>p</sub> ≤ 10 µs; T <sub>mb</sub> = 25 °C		-	318	А
Avalanche rug	gedness					
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$ \begin{array}{l} I_{D} = 27 \; A; \; V_{sup} \leq \; 100 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = \; 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ \hline Fig. 4 \end{array} $	[1]	-	173	mJ
I <sub>AS</sub>	non-repetitive avalanche current		[1]	-	27	A

[1] Protected by 100% test



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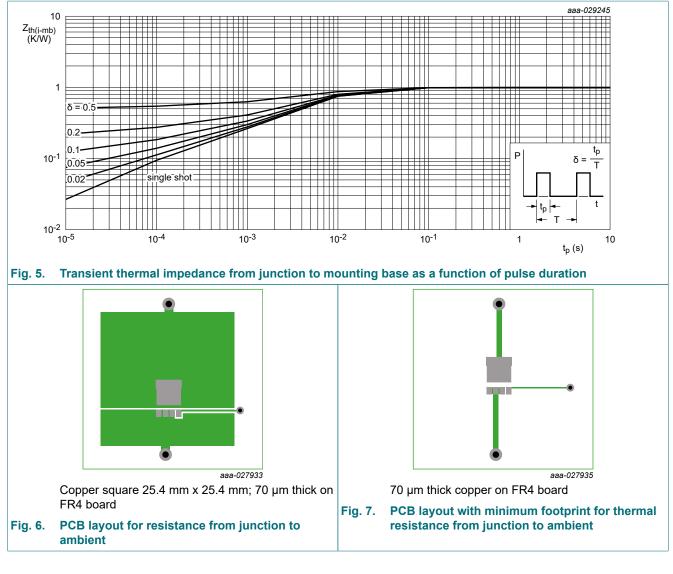


## 9. Thermal characteristics

## Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	0.87	0.99	K/W
R <sub>th(j-a)</sub>	junction to ambient	Fig. 6	-	42	-	K/W
		Fig. 7	-	85	-	K/W

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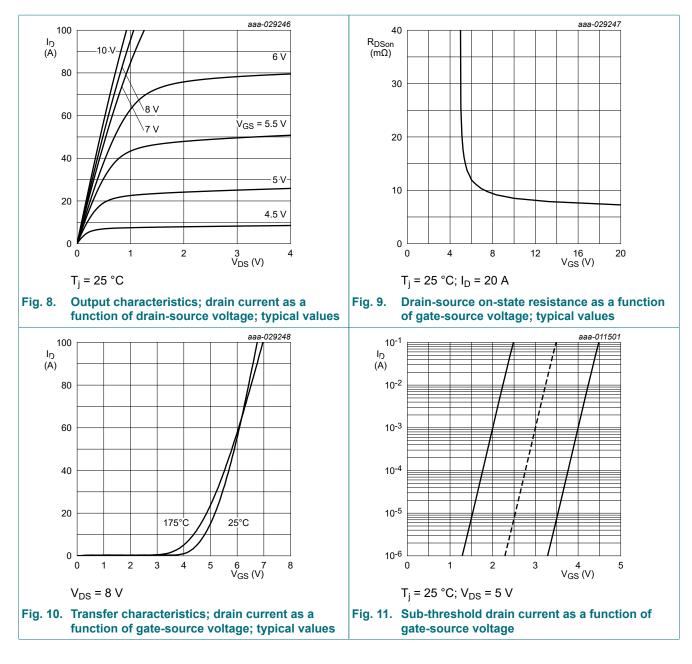
## **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	teristics	· · ·				
V <sub>(BR)DSS</sub>	drain-source	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = 25 \ ^{\circ}C$	100	-	-	V
	breakdown voltage	I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = -55 °C	90	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = -55 °C	-	3.6	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 175 °C	-	1.9	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> =V <sub>GS</sub> ; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	2	3.1	4	V
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 175 °C	-	-7.9	-	mV/K
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	0.02	5	μA
		V <sub>DS</sub> = 100 V; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 125 °C	-	-	100	μA
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 20 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	5	100	nA
		V <sub>GS</sub> = -20 V; V <sub>DS</sub> = 0 V; T <sub>i</sub> = 25 °C	-	5	100	nA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 12</u>	-	8.8	10.9	mΩ
		V <sub>GS</sub> = 7 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 12</u>	-	10.2	15.2	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 100 °C; <u>Fig. 13</u>	-	13.9	17.7	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 175 °C; <u>Fig. 13</u>	-	20	25.5	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz; T <sub>j</sub> = 25 °C	-	1.8	-	Ω
Dynamic ch	aracteristics	· · · ·	I			
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 20 A; V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 10 V; Fig. 14; Fig. 15	-	34.3	-	nC
		I <sub>D</sub> = 0 A; V <sub>DS</sub> = 0 V; V <sub>GS</sub> = 10 V	-	16.4	-	nC
Q <sub>GS</sub>	gate-source charge	I <sub>D</sub> = 20 A; V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 10 V; Fig. 14; Fig. 15	-	10.6	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge		-	6.4	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	4.2	-	nC
Q <sub>GD</sub>	gate-drain charge		-	8.1	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 20 A; V <sub>DS</sub> = 50 V; <u>Fig. 14</u> ; <u>Fig. 15</u>	-	4.9	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 50 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	-	2258	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 16</u>	-	395	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	21	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 2.5 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	10.2	-	ns
t <sub>r</sub>	rise time	R <sub>G(ext)</sub> = 5 Ω; T <sub>j</sub> = 25 °C	-	12.1	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	21.3	-	ns
t <sub>f</sub>	fall time		-	12.8	-	ns
Source-drai	n diode	· · ·	1			
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 20 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <u>Fig. 17</u>	-	0.85	1.2	V
t <sub>rr</sub>	reverse recovery time	$I_{S} = 20 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	38.4	-	ns
Q <sub>r</sub>	recovered charge	V <sub>DS</sub> = 50 V; <u>Fig. 18</u>	-	36.5	-	nC

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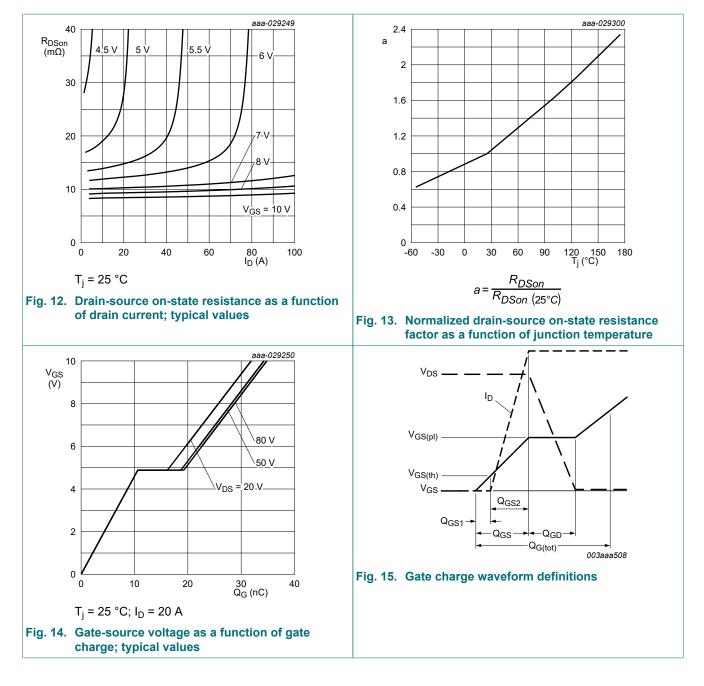
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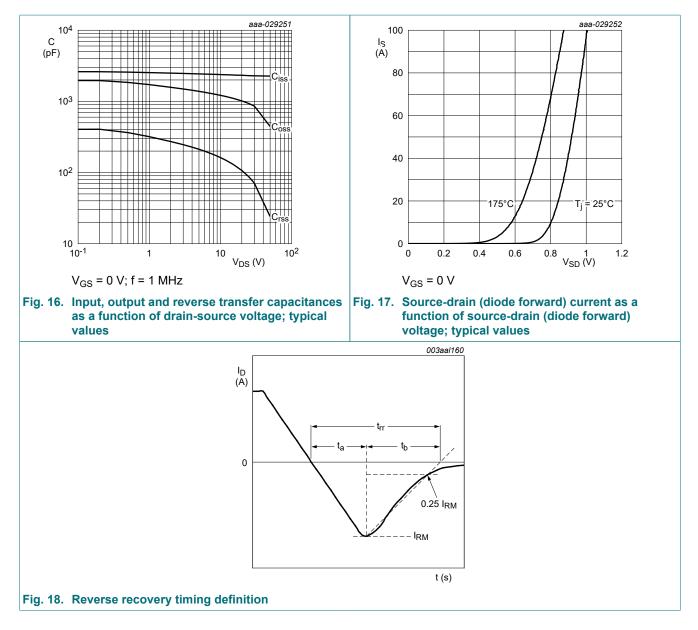
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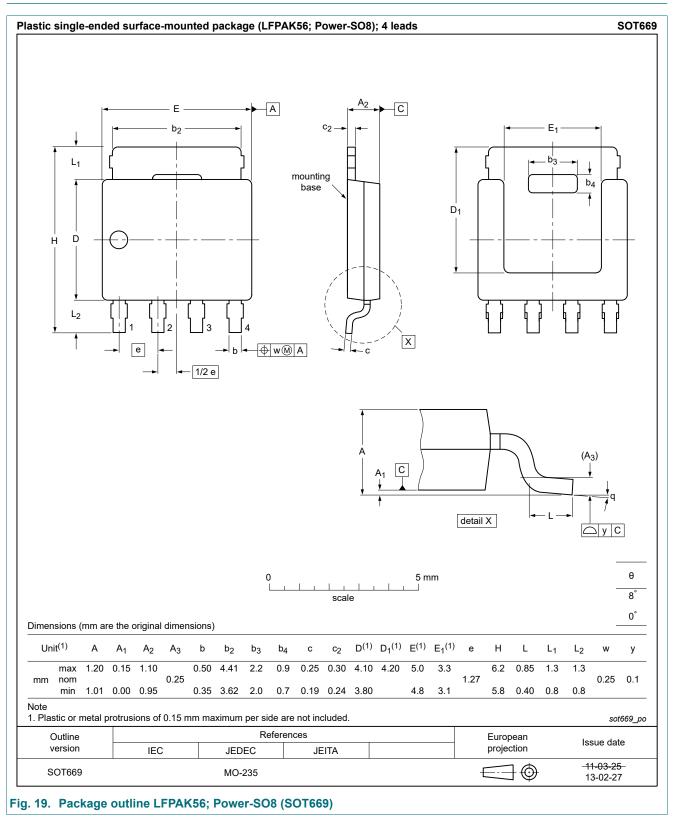
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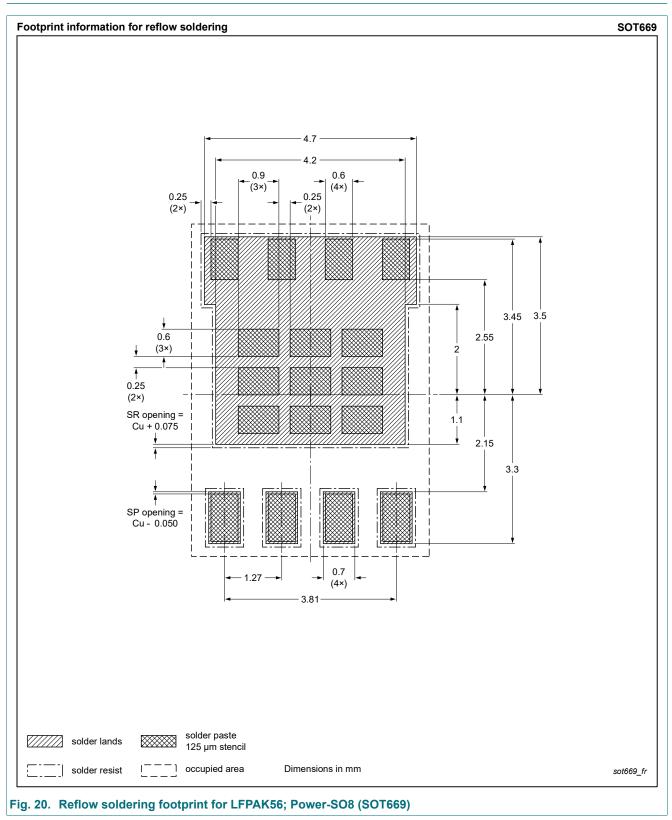
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## **11. Package outline**

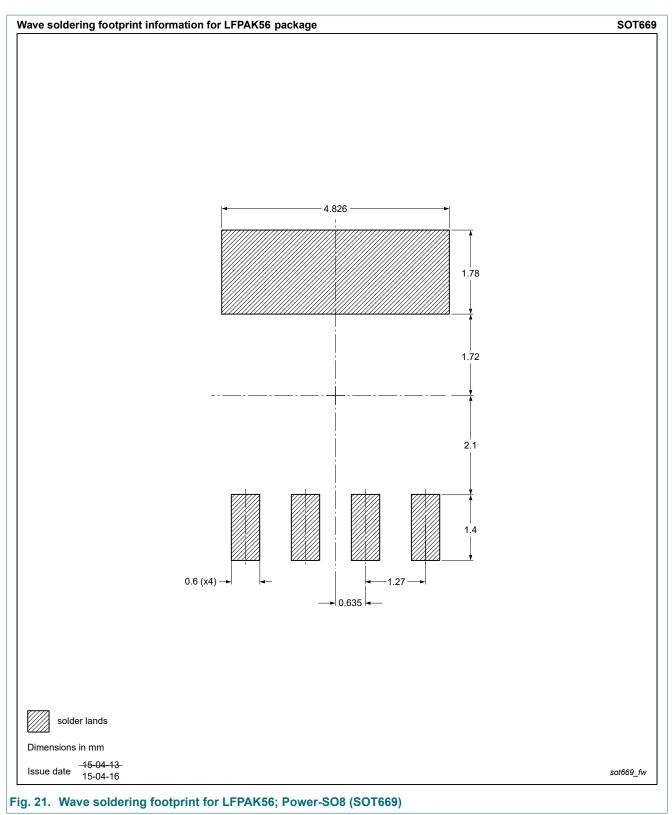


#### NextPower 100V, 10.9 m N-channel MOSFET in LFPAK56 package

## 12. Soldering



#### NextPower 100V, 10.9 m N-channel MOSFET in LFPAK56 package



#### NextPower 100V, 10.9 mΩ N-channel MOSFET in LFPAK56 package

## 13. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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